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Experience

Apple, Inc. New York, USA

Embedded controls engineer - Special Projects Group

Mar 2021 - Present

o Research and development for embedded control applications.

Butterfly Network New York, USA

Embedded engineer - C/C++ development for a portable ultrasound device

Aug 2019 - Mar 2021

o Designed and implemented a robust, RAM to EEPROM based, field update process for the bootloader on a Cypress FX3.

o Wrote proprietary, size-constrained drivers in C and C++ for inertial measurement units (IMU) such as ICM20948 and MPU9250

Eko Devices Berkeley, USA

Embedded engineering intern - R&D for a new product line of Bluetooth smart stethoscopes

Mar 2019 - Aug 2019

- o Responsible for the firmware development of Eko's new smart stethoscope model, based on the Cypress PSoC6 BLE microcontroller.
- o Implemented Bluetooth Low Energy (BLE) Over-The-Air (OTA) updates and physiological Digital Signal Processing (DSP) features.

Berkeley Emergent Space Tensegrities Lab.

Berkeley, USA

Graduate student researcher - embedded electronics for physiological data acquisition

Aug 2018 – Mar 2019

- o Lead designer of sensors for physiological data collection, focused on the integration of hardware, firmware, and validation studies.
- o Created a customized MicroPython firmware on STM32 to allow easy modification of the core parameters by the rest of the team.

DJI Hong Kong, HK

Robotics Institute firmware engineering intern - CAN bus communication and sensor fusion

Sep 2017 - Jun 2018

- o Developed a modular C library for the control system of four motors robotic platforms, to be deployed in drones and ground robots.
- o Designed a sensor-fusion based distance measurement system, using a Kalman filter with time of flight and infrared sensors.

Education

Politecnico di Milano

University of California, Berkeley

Berkeley, USA

Master of Engineering, Biomedical engineering, GPA: 3.88

2018 - 2019

o Graduate researcher at BEST Lab: embedded firmware development for physiological data acquisition and processing (ECG, EMG)

The Hong Kong University of Science and Technology (HKUST)

Hong Kong, HK

Bachelor of Engineering, Electronic Engineering, Exchange Student, GPA: 3.85

2017 - 2018

o Undergraduate researcher at HKUST Robotics institute: embedded engineering for robotics systems, CAN bus communication

Milan, IT

Bachelor of Science, Biomedical Engineering, GPA: 109/110 (3.96)

2015 - 2017

o Undergraduate research associate at NECST Lab: FPGA design applied to biomedical science, hardware accelerated image processing

The Sparthan Three-Dimensional Printed Exo-Glove: A Preliminary Evaluation of Performance

Berkeley, USA

Authors: Georgieu TA, Asnaghi D, Liang A, Agogino AM, ASME - Journal of Medical Devices

2020

Mechatronics enabling kit for 3D printed hand prostheses

Delft. NL

Authors: Wong TH, Asnaghi D, Leung W, International Conference on Engineering Design

2019

Projects

Publications...

Embedded firmware: 'Project Sparthan: Open source prosthetics development kit'

Jan 2018 - Current

- o Sparthan aims to provide children with responsive, low-cost, 3D printed prosthetic hands controlled by muscles' signals (EMG).
- o Created schematics and board layout for custom printed circuit board (PCB) in Altium Designer to reduce the device's footprint.
- o Developed a feed-forward neural network architecture in C++ running on STM32 micro-controller for hand gesture classification.

Embedded machine learning: 'An automatic ML-based characterization of lung cancer from PET and CT'

- o Development of an advanced medical imaging analysis pipeline in collaboration with NECST Lab and Humanitas hospital in Milan.
- o Designed an embedded machine learning approach using hardware accelerated classification on FPGA platform.
- o Presented results and our python based prototyping framework as a keynote speaker at the Xilinx Design Forum in San Jose (CA).

Skills

Programming: C, C++, Rust, Python, Javascript (React), Matlab, Arduino, TeX, Verilog, VHDL, git Languages: Italian (Native), English (Fluent: TOEFL 117/120), Chinese Mandarin (Basic proficiency, HSK I 192/200)